C0G Dielectric, 10 – 200 VDC (Commercial Grade)



Overview

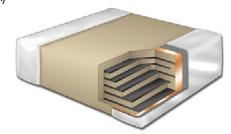
KEMET's COG dielectric features a 125°C maximum operating temperature and is considered "stable." The Electronics Components, Assemblies & Materials Association (EIA) characterizes COG dielectric as a Class I material. Components of this classification are temperature compensating and are suited for resonant circuit applications or those where Q and

stability of capacitance characteristics are required. COG exhibits no change in capacitance with respect to time and voltage and boasts a negligible change in capacitance with reference to ambient temperature. Capacitance change is limited to ±30 ppm/°C from -55°C to +125°C.

Benefits

- -55°C to +125°C operating temperature range
- RoHS Compliant
- EIA 0201, 0402, 0603, 0805, 1206, 1210, 1808, 1812, 1825, 2220, and 2225 case sizes
- DC voltage ratings of 10 V, 16 V, 25 V, 50 V, 100 V, and 200 V
- Capacitance offerings ranging from 0.5 pF up to 0.47 μF
- Available capacitance tolerances of ±0.10 pF, ±0.25 pF, ±0.5 pF, ±1%, ±2%, ±5%, ±10%, and ±20%
- · No piezoelectric noise
- Extremely low ESR and ESL
- · High thermal stability
- · High ripple current capability
- Preferred capacitance solution at line frequencies and into the MHz range

- · No capacitance change with respect to applied rated DC voltage
- Negligible capacitance change with respect to temperature from -55°C to +125°C
- · No capacitance decay with time
- · Non-polar device, minimizing installation concerns
- 100% pure matte tin-plated termination finish allowing for excellent solderability
- SnPb plated termination finish option available upon request (5% minimum)



Ordering Information

С	1206	С	104	J	3	G	Α	С	TU
Ceramic	Case Size (L" x W")	Specification/ Series ¹	Capacitance Code (pF)	Capacitance Tolerance ²	Voltage	Dielectric	Failure Rate/ Design	Termination Finish ³	Packaging/Grade (C-Spec) ⁴
	0201 0402 0603 0805 1206 1210 1808 1812 1825 2220 2225	C = Standard	2 significant digits + number of zeros. Use 9 for 1.0 – 9.9 pF Use 8 for 0.5 – .99 pF e.g., 2.2 pF = 229 e.g., 0.5 pF = 508	B = ±0.10 pF C = ±0.25 pF D = ±0.5 pF F = ±1% G = ±2% J = ±5% K = ±10% M = ±20%	8 = 10 V 4 = 16 V 3 = 25 V 5 = 50 V 1 = 100 V 2 = 200 V	G = C0G	A = N/A	C = 100% Matte Sn	Blank = Bulk TU = 7" Reel Unmarked

¹ Flexible termination option is available. Please see FT-CAP product bulletin C1062_COG_FT-CAP_SMD

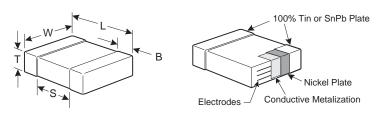
² Additional capacitance tolerance offerings may be available. Contact KEMET for details.

³ Additional termination finish options may be available. Contact KEMET for details.

⁴ Additional reeling or packaging options may be available. Contact KEMET for details.



Dimensions – Millimeters (Inches)



EIA Size Code	Metric Size Code	L Length	W Width	T Thickness	B Bandwidth	S Separation Minimum	Mounting Technique
0201	0603	0.60 (.024) ± 0.03 (.001)	0.30 (.012) ± 0.03 (.001)		0.15 (.006) ± 0.05 (.002)	N/A	Colder Deflow Only
0402	1005	1.00 (.040) ± 0.05 (.002)	0.50 (.020) ± 0.05 (.002)		0.30 (.012) ± 0.10 (.004)	0.30 (.012)	Solder Reflow Only
0603	1608	1.60 (.063) ± 0.15 (.006)	0.80 (.032) ± 0.15 (.006)		0.35 (.014) ± 0.15 (.006)	0.70 (.028)	
0805	2012	2.00 (.079) ± 0.20 (.008)	1.25 (.049) ± 0.20 (.008)		0.50 (0.02) ± 0.25 (.010)	0.75 (.030)	Solder Wave or Solder Reflow
1206	3216	3.20 (.126) ± 0.20 (.008)	1.60 (.063) ± 0.20 (.008)		0.50 (0.02) ± 0.25 (.010)		
1210	3225	3.20 (.126) ± 0.20 (.008)	2.50 (.098) ± 0.20 (.008)	See Table 2 for Thickness	0.50 (0.02) ± 0.25 (.010)		
1808	4520	4.70 (.185) ± 0.50 (.020)	2.00 (.079) ± 0.20 (.008)		0.60 (.024) ± 0.35 (.014)		
1812	4532	4.50 (.177) ± 0.30 (.012)	3.20 (.126) ± 0.30 (.012)		0.60 (.024) ± 0.35 (.014)	N/A	Colder Deflow Only
1825	4564	4.50 (.177) ± 0.30 (.012)	6.40 (.252) ± 0.40 (.016)		0.60 (.024) ± 0.35 (.014)		Solder Reflow Only
2220	5650	5.70 (.224) ± 0.40 (.016)	5.00 (.197) ± 0.40 (.016)		0.60 (.024) ± 0.35 (.014)		
2225	5664	5.60 (.220) ± 0.40 (.016)	6.40 (.248) ± 0.40 (.016)		0.60 (.024) ± 0.35 (.014)		

Applications

Typical applications include critical timing, tuning, circuits requiring low loss, circuits with pulse, high current, decoupling, bypass, filtering, transient voltage suppression, blocking and energy storage.

Qualification/Certification

Commercial Grade products are subject to internal qualification. Details regarding test methods and conditions are referenced in Table 4, Performance and Reliability.



Environmental Compliance

RoHS Compliant.



Electrical Parameters/Characteristics

Item	Parameters/Characteristics
Operating Temperature Range	-55°C to +125°C
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	±30 ppm/°C
Aging Rate (Maximum % Capacitance Loss/Decade Hour)	0%
Dielectric Withstanding Voltage (DWV)	250% of rated voltage (5 ±1 seconds and charge/discharge not exceeding 50 mA)
Dissipation Factor (DF) Maximum Limit @ 25°C	0.1%
Insulation Resistance (IR) Limit @ 25°C	1,000 megohm microfarads or 100 G Ω (Rated voltage applied for 120 ±5 seconds @ 25°C)

To obtain IR limit, divide $M\Omega$ - μ F value by the capacitance and compare to $G\Omega$ limit. Select the lower of the two limits. Capacitance and Dissipation Factor (DF) measured under the following conditions:

1 MHz ±100 kHz and 1.0 Vrms ±0.2 V if capacitance ≤ 1,000 pF

1 kHz \pm 50 Hz and 1.0 Vrms \pm 0.2 V if capacitance > 1,000 pF

Note: When measuring capacitance it is important to ensure the set voltage level is held constant. The HP4284 and Agilent E4980 have a feature known as Automatic Level Control (ALC). The ALC feature should be switched to "ON."

Post Environmental Limits

	High Temperatu	ıre Life, Biased	Humidity, Mois	ture Resistance	
Dielectric	Rated DC Voltage	Capacitance Value	Dissipation Factor (Maximum %)	Capacitance Shift	Insulation Resistance
C0G	All	All	0.5	0.3% or ±0.25 pF	10% of Initial Limit



Table 1A – Capacitance Range/Selection Waterfall (0201 – 1206 Case Sizes)

			Ser	ries				020)1			C0	402					C0(603					CO	805					C12	 206		
	Сар	Vo	ltag	e Cod	le		8	4	3	8	4	3	5	1	2	8	4	3	5	1	2	8	4	3	5	1	2	8	4	3	5	1	2
Capacitance	Code	v	olta	ge DC	;		ę	9	25	₽	9	25	20	100	200	9	16	25	20	9	200	₽	9	25	20	9	200	₽	9	25	20	9	200
				itan						•			P					bilit or C									S						
0.50 – 0.75 pF	508 – 758	ВСД		anc						ВВ	BB	BB	ВВ	00	- 10	СВ	СВ	СВ	СВ	СВ	_	DC	DC	_	_	DC	DC						
1.0 – 1.6 pF	109 – 169	BCD			K	M				ВВ	BB	BB	ВВ			СВ	СВ	СВ	СВ	СВ	СВ	DC	DC	DC		DC		EB	EB	EB	EB	EB	EB
1.8 – 4.3 pF	189 – 439	BCD		J	K	M				BB	BB	BB	BB			CB	CB	CB	СВ	CB		DC	DC	DC		DC		EB	EB	EB	EB	EB	EB
4.7 – 9.1 pF 10 pF	479 100	B C D		G J	K	M	 Λ D1	AB¹	Λ D1	BB	BB BB	BB BB	BB BB			CB CB	CB CB	CB CB	CB CB	CB CB	CB CB	DC DC	DC DC	DC DC		DC DC		EB EB	EB EB	EB EB	EB EB	EB EB	EB EB
11 pF	110	BCD		G J	K	M	AD	AD	AD	BB	BB	BB	BB			СВ	СВ	СВ	СВ	СВ	СВ	DC	DC	DC		DC	DC	EB	EB	EB	EB	EB	EB
12 pF	120	BCD		GJ	K	M	AB ²	AB ²	AB ²		BB	BB	ВВ			СВ	СВ	СВ	СВ	СВ		DC	DC	DC		DC	DC	EB	EB	EB	EB	EB	EB
13 pF	130	CD	F	G J	K	M	l			ВВ	ВВ	ВВ	ВВ			СВ	СВ	СВ	СВ	СВ	СВ	DC	DC	DC	DC	DC	DC	EB	EB	EB	EB	ΕB	EB
15 pF	150	CD		GJ	K	M	AB ²	AB ²	AB ²		BB	BB	ВВ			СВ	СВ	СВ	СВ	СВ	СВ	DC	DC	DC		DC	DC	EB	EB	EB	EB	ΕB	EB
16 pF	160	CD		G J	K	M		A D2	4 D2	BB	BB	BB	BB			CB	CB	CB	CB	CB	CB	DC	DC	DC	_	DC	DC	EB	EB	EB	EB	EB	EB
18 pF 20 pF	180 200	CD		G J	K	M	AB.	AB ²	AB-	BB	BB BB	BB BB	BB BB			CB CB	CB CB	CB CB	CB CB	CB CB	CB CB	DC DC	DC DC	DC DC		DC DC		EB EB	EB EB	EB EB	EB EB	EB EB	EB EB
22 pF	220	CD		G J	K	M	AB ²	AB ²	AB ²		BB	BB	BB			СВ	CB	CB	CB	CB		DC	DC	DC		DC			EB	EB	EB	EB	EB
24 pF	240	CD		G J	K	M				ВВ	BB	BB	BB			СВ	СВ	СВ	СВ	СВ	СВ	DC	DC	DC		DC		EB	EB	EB	EB	EB	EB
27 pF	270	CD	_	G J	K	M	AB ²	AB ²	AB ²		BB	BB	ВВ			СВ	СВ	СВ	СВ	СВ		DC	DC	DC	_	DC	_		EB	EB	EB	EB	EB
30 pF	300	CD		GJ	K	M	١, ۲	A D2	4.02	BB	BB	BB	BB			CB	CB	CB	CB	CB	CB	DC	DC	DC		DC	DC	EB	EB	EB	EB	EB	EB
33 pF 36 pF	330 360	CD		G J	K	M	AB,	AB ²	AB ²	BB	BB BB	BB BB	BB BB			CB CB	CB CB	CB CB	CB CB	CB CB	CB CB	DC DC	DC DC	DC DC		DC DC	DC DC	EB EB	EB EB	EB EB	EB EB	EB EB	EB EB
39 pF	390			GJ	K	M	AB2	AB ²	AB ²		BB	BB	BB			СВ	СВ	CB	CB	CB	СВ	DC	DC	DC		DC	DC	EB	EB	EB	EB	EB	EB
43 pF	430			GJ	K	M		-		BB	BB	BB	BB			СВ	СВ	СВ	СВ	СВ	СВ	DC	DC	DC		DC		EB	EB	EB	EB	EB	EB
47 pF	470	D		G J	K	M	AB²	AB ²	AB ²		BB	BB	ВВ			СВ	СВ	СВ	СВ	СВ		DC	DC	DC		DC			EB	EB	EB	EB	EB
51 pF	510	D		G J	K	M	١, ,			BB	BB	BB	BB			СВ	CB	CB	СВ	СВ	СВ	DC	DC	DC		DC		EB	EB	EB	EB	EB	EB
56 pF 62 pF	560 620			G J	K	M	AB,	AB ²	AB ²	BB	BB BB	BB BB	BB BB			CB CB	CB CB	CB CB	CB CB	CB CB	CB CB	DC DC	DC DC	DC DC		DC DC		EB EB	EB EB	EB EB	EB EB	EB EB	EB EB
68 pF	680			G J	K	M	l _{AB2}	AB ²	AB ²		BB	BB	BB			СВ	СВ	СВ	СВ	СВ		DC	DC	DC		DC			EB	EB	EB	EB	EB
75 pF	750		_	G J	K	M	,	,	,,,,	BB	BB	BB	BB			СВ	СВ	СВ	СВ	СВ	СВ	DC	DC	DC		DC	DC	EB	EB	EB	EB	EB	EB
82 pF	820			G J	K	M	AB ²	AB ²	AB ²	ВВ	ВВ	ВВ	ВВ			СВ	СВ	СВ	СВ	СВ		DC	DC	DC	DC	DC	DC	EB	EB	EB		EB	EB
91 pF	910			G J	K	M	l			ВВ	BB	BB	ВВ			СВ	СВ	СВ	СВ	СВ	СВ	DC	DC	DC		DC	DC	EB	EB	EB	EB	EB	EB
100 pF	101			GJ	K	M	AB ²	AB ²	AB²		BB	BB	BB	BB BB		CB	CB	CB	CB	CB		DC	DC	DC		DC	DC	EB EB	EB	EB	EB EB	EB	EB EB
110 – 180 pF 200 – 330 pF	111 – 181 201 – 331		-	G J	K	M				BB BB	BB BB	BB BB	BB BB	BB		CB CB	CB CB	CB CB	CB CB	CB CB	CB UD	DC DC	DC DC	DC DC	_	DC	DC	_	EB EB	EB EB	EB	EB EB	EB
360 – 560 pF	361 – 561			G J	K	M				BB	BB	BB	BB	BB		СВ	CB	CB	CB		UD		DC	DC		DC		EB	EB	EB	EB	EB	EB
620 – 820 pF	621 – 821			G J	K	M				ВВ	ВВ	ВВ	ВВ	ВВ		СВ	СВ	СВ	СВ	СВ	UD	DC	DC	DC	DC	DC	DC		EB	EB	EB	EB	EB
910 pF	911			G J	K	M				BB	BB	BB	ВВ	ВВ		СВ	СВ	СВ	СВ	СВ	UD		DC	DC		DD	DD	EB	EB	EB	EB	EB	EB
1,000 pF	102			G J	K	M				BB BB	BB BB	BB BB	BB BB	BB		CB CB	CB	CB CB	CB CB	CB CB	UD UD		DC DC	DC DC		DD	_	_	EB EB	EB EB	EB	EB EB	EB EB
1,100 pF 1,200 pF	112 122			G J	K	M				BB	BB	BB	BB			СВ	CB CB	СВ	СВ	СВ	UD		DC	DC		DC	UD UD		EB	EB	EB EB	EB	EB
1,300 pF	132			GJ	K	M				BB	BB	BB	BB			СВ	СВ	CB	CB	СВ	UD		DD	DD		DD	UD		EB	EB	EB	EC	EC
1,500 pF	152			G J	K	M				ВВ	ВВ	ВВ	ВВ			СВ	СВ	СВ	СВ	СВ	UD		DD	DD	DD	DD	UD	EΒ	EB	EB	EB	ED	EC
1,600 pF	162			G J	K	M	L			BB	BB	BB				СВ	СВ	СВ	СВ	СВ	UD		DD	DD	_	DD			EB	EB	EB	ED	ED
1,800 pF	182			GJ	K	M				BB	BB	BB				CB	CB	CB	CB			DD			DD				EB	EB	EB	ED	ED
2,000 pF 2,200 pF	202 222		1 1	G J	K	M				BB	BB BB	BB				CB CB	CB	CB CB	CB CB	CB CB	עט חוו	DC	DC	DC	DC		UD UD		EB EB	EB EB	EB EB	ED EE	ED EE
2,400 pF	242			GJ	K					00	DD							CB		СВ	טט						UD		EB	EB	EB	EC	
2,700 pF	272			G J	K												СВ	СВ	СВ	СВ		DC	DC	DC	DC	DC	UD	EB	EB			EC	
3,000 pF	302		F	G J	K	M										СВ	СВ	СВ	СВ	СВ		DD	DD	DD	DD	DC	UD	EC	EC	EC	EC	EC	UD
3,300 pF	332			GJ	K												СВ					DD				DC	UD	EC	EC	EC		EE	
3,600 pF 3,900 pF	362 392			G J	K	M										CB CB	CB CB	CB	CB CB	CB		DD DE	DD DE		DD DE		UD UD		EC EC	EC EC	EC EC	EE EF	
4,300 pF	432			G J			l									СВ	СВ		СВ			DE			DE		UD		EC	EC		EC	
4,700 pF	472		_	G J	K											СВ	СВ	CB	CB				DE	DE	DE	DC	UD	EC	EC	EC	EC	EC	
5,100 pF	512			G J	K	M												СВ				DE	DE	DE	DE	DC	UD	ED		ED	ED	ED	UE
5,600 pF	562	بلللا		G J		M	L	-	10			10		0	0	СВ	_	_	-	0	0	-		_					ED	ED	-		UE
_	Сар			ge DC			9	9	52	 	9	22		190	200	9	9	, 25	20	9	200	10 16 25 50 100			500	9	9	, 25	20	19	200		
Capacitance	Code			e Cod	le		8	4	3	8	4	3	5	1	2	8	4	3	5	1	2				2	8	4	3	5	1	2		
			Ser	ies			<u> </u>	020)1			C0	402					CO	603			C0805						C12	206				

UD = Under development

xx1 Available only in K,M tolerance

xx² Available only in M tolerance.

These products are protected under US Patents 7,172,985 & 7,670,981, other patents pending, and any foreign counterparts.



Table 1A - Capacitance Range/Selection Waterfall (0201 - 1206 Case Sizes) cont'd

		Series	C	:020)1			C0	402					C0	603					CO	805					C12	206		
Conneitance	Сар	Voltage Code	8	4	3	8	4	3	5	1	2	8	4	3	5	1	2	8	4	3	5	1	2	8	4	3	5	1	2
Capacitance	Code	Voltage DC	2	9	22	9	9	25	20	100	200	10	9	25	20	190	200	ę	9	22	20	190	200	ę	9	52	20	100	200
		Capacitance Tolerance							Р									Th					s						
6,200 pF	622	F G J K M										СВ	СВ	СВ	СВ			DC	DC	DC	DC	DC	UD	EB	EB	EB	EB	EB	UD
7,500 pF	752	F G J K M				l						СВ	СВ	СВ				DC	DC	DC	DC	DC	UD	EB	EB	EB	EB	EB	UD
8,200 pF	822	F G J K M										СВ	СВ	СВ				DC	DC	DC	DC	DC	UD	EC	EC	EC	EC	EB	UD
9,100 pF	912	F G J K M				l						CB	СВ	СВ				DC	DC	DC	DC	DC		EC	EC	EC	EC	EB	UD
10,000 pF	103	F G J K M				l						CB	СВ	CB				DC	DC	DC	DC	DD		ED	ED	ED	ED	EB	UD
12,000 pF	123	F G J K M				l						CB	СВ	CB				DC	DC	DC	DC	DE		EB	EB	EB	EB	EB	UD
15,000 pF	153	F G J K M				l						CB	СВ	СВ				DC	DC	DC	DD	DG		EB	EB	EB	EB	EB	UD
18,000 pF	183	F G J K M																DC	DC	DC	DD			EB	EB	EB	EB	EB	UD
22,000 pF	223	F G J K M																DD	DD	DD	DF			EB	EB	EB	EB	EC	UD
27,000 pF	273	F G J K M																DF	DF	DF				EB	EB	EB	EB	EE	
33,000 pF	333	F G J K M																DG	DG	DG				EB	EB	EB	EB	EE	
39,000 pF	393	F G J K M																DG	DG	DG				EC	EC	EC	EE	EH	
47,000 pF	473	F G J K M																DG	DG	DG				EC	EC	EC	EE	EH	
56,000 pF	563	F G J K M				l																		ED	ED	ED	EF		
68,000 pF	683	F G J K M				l																		EF	EF	EF	EH		
82,000 pF	823	F G J K M				l																		EH	EH	EH	EH		
0.10 µF	104	F G J K M																						EH	EH	EH			
	_	Voltage DC	9	16	25	10	16	25	20	100	200	10	16	25	50	100	200	10	16	25	20	100	200	10	16	25	50	100	200
Capacitance	Cap Code	Voltage Code	8	4	3	8	4	3	5	1	2	8	4	3	5	1	2	8	4	3	5	1	2	8	4	3	5	1	2
	Code	Series	C	020)1			C0	402					C0	603					CO	805					C1:	206		

Table 1B - Capacitance Range/Selection Waterfall (1210 - 2225 Case Sizes)

			5	Ser	ies					C12	210			C	180	8	(C181	2	C	182	5	C	222	0	C	222	5
Consolitores	Cap		Vol	tage	e Coc	le		8	4	3	5	1	2	5	1	2	5	1	2	5	1	2	3	1	2	5	1	2
Capacitance	Code		Vo	oltag	ge DC	;		9	16	22	20	100	200	50	100	200	50	100	200	50	100	200	20	100	200	50	100	200
					itan		T					•	Pro		Ava	ilabi		nd C	hip 1		nes	s Co		•				- ' '
			To	ler	anc	е							S	ee Ta	able	2 for	Chip	Thi	ckne	ss D	imen	sion	S					
0.5 – 0.75 pF	508 – 758	В	D																									
1.0 – 1.6 pF	109 – 169	B (D			K	M	FB	FB	FB	FB	FB	FB															
1.8 – 4.3 pF	189 – 439	B	D		J	K	M	FB	FB	FB	FB	FB	FB															
4.7 – 9.1 pF	479 – 919	В	D		GJ	K	М	FB	FB	FB	FB	FB	FB															
10 – 12 pF	100 – 120	В	D	F	GJ	K	М	FB	FB	FB	FB	FB	FB															
13 – 33 pF	130 – 330		D		G J	K	М	FB	FB	FB	FB	FB	FB															
36 – 62 pF	360 – 620	i	D	F	GJ	K	М	FB	FB	FB	FB	FB	FB										İ					
68 – 91 pF	680 – 910	i		F	G J	K	М	FB	FB	FB	FB	FB	FB	l			İ			İ			İ					
100 – 300 pF	101 – 301			F	G J	K	М	FB	FB	FB	FB	FB	FB				İ						İ					
330 – 430 pF	331 – 431			F	G J	K	М	FB	FB	FB	FB	FB	FB	LF	LF	LF												
470 – 910 pF	471 – 911			F	G J	K	М	FB	FB	FB	FB	FB	FB	LF	LF	LF	GB	GB	GB									
1,000 pF	102			F	G J	K	М	FB	FB	FB	FB	FB	FB	LF	LF	LF	GB	GB	GB				i					
1,100 pF	112	i		F	G J	K	М	FB	FB	FB	FB	FB	FB	LF	LF	LF	GB	GB	GB				i					
1,200 pF	122			F	G J	K	М	FB	FB	FB	FB	FB	FB	LF	LF	LF	GB	GB	GB				i					
1,300 pF	132			F	G J	K	М	FB	FB	FB	FB	FB	FC	LF	LF	LF	GB	GB	GB									
1,500 pF	152			F	G J	K	М	FB	FB	FB	FB	FB	FE	LF	LF	LF	GB	GB	GB									
1,600 pF	162			F	G J	K	м	FB	FB	FB	FB	FB	FE	LF	LF	LF	GB	GB	GB				İ					
1,800 pF	182	i		F	GJ			FB	FB	FB	FB	FB	FE	LF	LF	LF	GB	GB	GB				İ					
2,000 pF	202	i		F	GJ	K	М	FB	FB	FB	FB	FC	FE	LF	LF	LF	GB	GB	GB				İ					
2,200 pF	222			F	GJ	K	М	FB	FB	FB	FB	FC	FG	LF	LF	LF	GB	GB	GB				İ					
2,400 pF	242			F	G J	K	М	FB	FB	FB	FB	FC	FC	LF	LF	LF												
			Vo	oltaç	ge DC	;		9	16	25	20	100	200	50	100	200	50	9	200	50	100	200	20	100	200	50	9	200
Capacitance	Cap Code		Vol	tage	e Coc	le		8	4	3	5	1	2	5	1	2	5	1	2	5	1	2	3	1	2	5	1	2
				Ser	ies					C1:	210			(180	3	(C181:	2	(182	5		222	0	C	222	5

UD = Under development

These products are protected under US Patents 7,172,985 & 7,670,981, other patents pending, and any foreign counterparts.



Table 1B - Capacitance Range/Selection Waterfall (1210 - 2225 Case Sizes) cont'd

		Series			C12	210			C	180	8	C	181	2	C	182	5	C	222	0	C	222	5
Canacitanas	Сар	Voltage Code	8	4	3	5	1	2	5	1	2	5	1	2	5	1	2	3	1	2	5	1	2
Capacitance	Code	Voltage DC	9	16	25	20	100	200	50	100	200	50	100	200	50	100	200	20	100	200	50	100	200
		Capacitance Tolerance								Ava				hip ⁻ ckne									
2,700 pF 3,000 pF	272 302	F G J K M F G J K M	FB FB	FB FB	FB FB	FB FB	FC FC	FC FF	LF LF	LF LF	LF	GB	GB	GB									
3,300 pF	332	F G J K M	FB	FB	FB	FB	FF	FF	LF	LF		GB	GB	GB									
3,600 pF	362	F G J K M	FB	FB	FB	FB	FF	FF	LF	LF		OB	OB	00									
3,900 pF	392	F G J K M	FB	FB	FB	FB	FF	FF	LF	LF		GB	GB	GB	НВ	НВ	НВ						
4,300 pF	432	F G J K M		FB	FB	FB	FF	FF	LF	LF								•					
4,700 pF	472	F G J K M		FF	FF	FF	FG	FG	LF	LF		GB	GB	GD	НВ	HB	HB				KE	KE	KE
5,100 pF	512	F G J K M		FB	FB	FB	FG	FG													KE	KE	KE
5,600 pF	562	F G J K M	FB	FB	FB	FB	FG	FG				GB	GB	GH	НВ	НВ	НВ				KE	KE	KE
6,200 pF 6,800 pF	622 682	F G J K M F G J K M	FB FB	FB FB	FB FB	FB FB	FG FG	UD UD				GB	GB	GJ	НВ	НВ	НВ	JE	JE		KE KE	KE KE	KE KE
7,500 pF	752	FGJKM FGJKM	FC	FC	FC	FC	FC	UD				GB	GB	GJ	ПВ	пв	ПВ	JE	JE		KE	KE	KE
8,200 pF	822	F G J K M	FC	FC	FC	FC	FC	UD				GB	GH	UD	НВ	НВ	НВ	JE	JE		KE	KE	KE
9,100 pF	912	F G J K M	FE	FE	FE	FE	FE	UD				OB	011	UD	110	'''	110	32	JL		KE	KE	KE
10,000 pF	103	F G J K M	FF	FF	FF	FF	FF	UD				GB	GH	UD	НВ	НВ	HE	JE	JE		KE	KE	KE
12,000 pF	123	F G J K M	FG	FG	FG	FG	FB	UD				GB	GG	UD	НВ	НВ	HE	JE	JE		KE	KE	KE
15,000 pF	153		FG	FG	FG	FG	FB	UD				GB	GB	UD	НВ	HB		JE	JE		KE	KE	KE
18,000 pF	183			FB	FB	FB	FB	UD				GB	GB	UD	НВ	HE		JE	JE		KE	KE	
22,000 pF	223	F G J K M	FB	FB	FB	FB	FB	UD				GB	GB	UD	HB	HE		JE	JB		KE	KE	
27,000 pF	273	F G J K M	FB	FB	FB	FB	FB	UD				GB	GB	UD	НВ	HG		JE	JB		KE	KE	
33,000 pF 39,000 pF	333 393	F G J K M F G J K M	FB FB	FB FB	FB FB	FB FB	FB FE	UD UD				GB GB	GB GB	UD UD				JB JB	JB JB		KE		
47,000 pF	393 473	F G J K M F G J K M	FB	FB	FB	FB	FE	UD				GB	GB	UD				JB	JB		ł		
56,000 pF	563	F G J K M	FB	FB	FB	FB	FF	UD				GB	GB	UD				JB	JB		l		
68,000 pF	683	F G J K M		FB	FB	FC	FG					GB	GB	UD				JB	JB				
82,000 pF	823	F G J K M	FC	FC	FC	FF	FH					GB	GB	ÜD				JB	JB		İ		
0.10 µF	104	F G J K M	FE	FE	FE	FG	FM					GB	GD	UD				JB	JB		İ		
0.12 µF	124		FG	FG	FG	FH						GB	GH					JB	JB				
0.15 µF	154	F G J K M		FH	FH	FM						GD	GN					JB	JB				
0.18 µF	184	F G J K M	FJ	FJ	FJ							GH						JB	JD				
0.22 µF	224	F G J K M	FK	FK	FK							GK						JB	JD				
0.27 µF	274	F G J K M																JB	JF				
0.33 μF 0.39 μF	334 394	F G J K M F G J K M																JD JG	JG				
0.39 μF 0.47 μF	394 474	F G J K M																JG					
ν.τι μι	717	Voltage DC	9	9	25	20	100	200	20	100	200	20	100	200	20	9	200	20 2	100	200	20	100	700
Capacitance	Cap Code	Voltage Code	8	4	3	5	1	2	5	1	2	5	1	2	5	1	2	3	1	2	5	1	2
	Code	Series			C12	210			(1808	3		1812	2	(182	5		222	0		222	5

UD = Under development

These products are protected under US Patents 7,172,985 & 7,670,981, other patents pending, and any foreign counterparts.



Table 2 – Chip Thickness/Packaging Quantities

Thickness	Case	Thickness ±	Paper G	uantity	Plastic (Quantity
Code	Size	Range (mm)	7" Reel	13" Reel	7" Reel	13" Reel
AB BB CB DC	0201 0402 0603 0805	0.30 ± 0.03 0.50 ± 0.05 0.80 ± 0.07	15,000 10,000 4,000 4,000	0 50,000 10,000	0 0 0 0	0 0 0
DD	0805	0.78 ± 0.10 0.90 ± 0.10	4,000	10,000 10,000	0	0
DE	0805	1.00 ± 0.10	0	0	2,500	10,000
DF	0805	1.10 ± 0.10	0	0	2,500	10,000
DG	0805	1.25 ± 0.15	0	0	2,500	10,000
EB	1206	0.78 ± 0.10	4,000	10,000	4,000	10,000
EC	1206	0.90 ± 0.10	0	0	4,000	10,000
ED	1206	1.00 ± 0.10	0	0	2,500	10,000
EE	1206	1.10 ± 0.10	0	0	2,500	10,000
EF	1206	1.20 ± 0.15	0	0	2,500	10,000
EH	1206	1.60 ± 0.20	0	0	2,000	8,000
FB	1210	0.78 ± 0.10		0	4,000	10,000
FC	1210	0.90 ± 0.10	0	0	4,000	10,000
FE	1210	1.00 ± 0.10	0	0	2,500	10,000
FF	1210	1.10 ± 0.10	0	0	2,500	10,000
FG FH	1210 1210	1.25 ± 0.15 1.55 ± 0.15	0	0	2,500 2,000	10,000 8,000
FM	1210	1.70 ± 0.20	0	0	2,000	8,000
FJ	1210	1.85 ± 0.20	0	0	2,000	8,000
FK	1210	2.10 ± 0.20	0	0	2,000	8,000
NC	1706	1.00 ± 0.15	0	0	4,000	10,000
LF	1808	1.00 ± 0.15	0	0	2,500	10,000
GB	1812	1.00 ± 0.10	0	0	1,000	4,000
GD GH GG	1812 1812 1812	1.25 ± 0.15 1.40 ± 0.15 1.55 ± 0.10	0 0 0	0 0 0	1,000 1,000 1,000	4,000 4,000 4,000 4,000
GK	1812	1.60 ± 0.20	0	0	1,000	4,000
GJ	1812	1.70 ± 0.15	0	0	1,000	4,000
GN	1812	1.70 ± 0.20	0	0	1,000	4,000
HB	1825	1.10 ± 0.15	0	0	1,000	4,000
HE	1825	1.40 ± 0.15	0	0	1,000	4,000
HG	1825	1.60 ± 0.20	0	0	1,000	4,000
JB JD JE	2220 2220 2220 2220	1.00 ± 0.15 1.30 ± 0.15 1.40 ± 0.15	0 0 0	0 0 0	1,000 1,000 1,000	4,000 4,000 4,000
JF JG	2220 2220	1.50 ± 0.15 1.70 ± 0.15	0	0	1,000 1,000	4,000 4,000
KE	2225	1.40 ± 0.15 Thickness ±	0	0	1,000	4,000
Thickness	Case		7" Reel	13" Reel	7" Reel	13" Reel
Code	Size	Range (mm)	Paper C	luantity	Plastic (Quantity

Package quantity based on finished chip thickness specifications.



Table 3 - Chip Capacitor Land Pattern Design Recommendations per IPC-7351

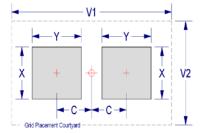
EIA Size Code	Metric Size Code	ı	Maxi	sity Lev mum (I rotrusio)		Media	sity Lev an (Nor rotrusio)			sity Lev mum (L rotrusio	east))
Couc	Couc	С	Υ	Х	V1	V2	С	Υ	Х	V1	V2	С	Υ	Х	V1	V2
0201	0603	0.38	0.56	0.52	1.80	1.00	0.33	0.46	0.42	1.50	0.80	0.28	0.36	0.32	1.20	0.60
0402	1005	0.50	0.72	0.72	2.20	1.20	0.45	0.62	0.62	1.90	1.00	0.40	0.52	0.52	1.60	0.80
0603	1608	0.90	1.15	1.10	4.00	2.10	0.80	0.95	1.00	3.10	1.50	0.60	0.75	0.90	2.40	1.20
0805	2012	1.00	1.35	1.55	4.40	2.60	0.90	1.15	1.45	3.50	2.00	0.75	0.95	1.35	2.80	1.70
1206	3216	1.60	1.35	1.90	5.60	2.90	1.50	1.15	1.80	4.70	2.30	1.40	0.95	1.70	4.00	2.00
1210	3225	1.60	1.35	2.80	5.65	3.80	1.50	1.15	2.70	4.70	3.20	1.40	0.95	2.60	4.00	2.90
1210¹	3225	1.50	1.60	2.90	5.60	3.90	1.40	1.40	2.80	4.70	3.30	1.30	1.20	2.70	4.00	3.00
1808	4520	2.30	1.75	2.30	7.40	3.30	2.20	1.55	2.20	6.50	2.70	2.10	1.35	2.10	5.80	2.40
1812	4532	2.15	1.60	3.60	6.90	4.60	2.05	1.40	3.50	6.00	4.00	1.95	1.20	3.40	5.30	3.70
1825	4564	2.15	1.60	6.90	6.90	7.90	2.05	1.40	6.80	6.00	7.30	1.95	1.20	6.70	5.30	7.00
2220	5650	2.75	1.70	5.50	8.20	6.50	2.65	1.50	5.40	7.30	5.90	2.55	1.30	5.30	6.60	5.60
2225	5664	2.70	1.70	6.90	8.10	7.90	2.60	1.50	6.80	7.20	7.30	2.50	1.30	6.70	6.50	7.00

¹ Only for capacitance values ≥ 22 μF

Density Level A: For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes. KEMET only recommends wave soldering of EIA 0603, 0805 and 1206 case sizes.

Density Level B: For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes.

Density Level C: For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC Standard 7351 (IPC-7351).



Soldering Process

Recommended Soldering Technique:

- Solder wave or solder reflow for EIA case sizes 0603, 0805 and 1206
- All other EIA case sizes are limited to solder reflow only

Recommended Soldering Profile:

• KEMET recommends following the guidelines outlined in IPC/JEDEC J-STD-020



Table 4 – Performance & Reliability: Test Methods and Conditions

Stress	Reference	Test or Inspection Method
Terminal Strength	JIS-C-6429	Appendix 1, Note: Force of 1.8 kg for 60 seconds.
Board Flex	JIS-C-6429	Appendix 2, Note: Standard termination system – 2.0 mm (minimum) for all except 3 mm for C0G. Flexible termination system – 3.0 mm (minimum).
		Magnification 50 X. Conditions:
Coldorability	J-STD-002	a) Method B, 4 hours @ 155°C, dry heat @ 235°C
Solderability	J-31D-002	b) Method B @ 215°C category 3
		c) Method D, category 3 @ 260°C
Temperature Cycling	JESD22 Method JA-104	1,000 Cycles (-55°C to +125°C). Measurement at 24 hours +/- 2 hours after test conclusion.
D: 111 · 151	MII. OTD 000 M II. 1400	Load Humidity: 1,000 hours 85°C/85% RH and rated voltage. Add 100 K ohm resistor. Measurement at 24 hours +/- 2 hours after test conclusion.
Biased Humidity	MIL-STD-202 Method 103	Low Volt Humidity: 1,000 hours 85°C/85% RH and 1.5 V. Add 100 K ohm resistor. Measurement at 24 hours +/- 2 hours after test conclusion.
Moisture Resistance	MIL-STD-202 Method 106	t = 24 hours/cycle. Steps 7a and 7b not required. Unpowered. Measurement at 24 hours +/- 2 hours after test conclusion.
Thermal Shock	MIL-STD-202 Method 107	-55°C/+125°C. Note: Number of cycles required – 300, maximum transfer time – 20 seconds, dwell time – 15 minutes. Air – Air.
High Temperature Life	MIL-STD-202 Method 108 /EIA-198	1,000 hours at 125°C (85°C for X5R, Z5U and Y5V) with 2 X rated voltage applied.
Storage Life	MIL-STD-202 Method 108	150°C, 0 VDC for 1,000 hours.
Vibration	MIL-STD-202 Method 204	5 g's for 20 min., 12 cycles each of 3 orientations. Note: Use 8" X 5" PCB 0.031" thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10 – 2,000 Hz
Mechanical Shock	MIL-STD-202 Method 213	Figure 1 of Method 213, Condition F.
Resistance to Solvents	MIL-STD-202 Method 215	Add aqueous wash chemical, OKEM Clean or equivalent.

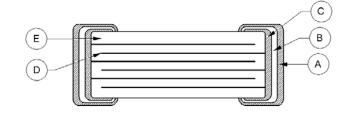
Storage and Handling

Ceramic chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature—reels may soften or warp and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 70% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability chip stock should be used promptly, preferably within 1.5 years of receipt.



Construction

Reference	Ite	em	Material
A		Finish	100% Matte Sn
В	Termination System	Barrier Layer	Ni
С	.,	Base Metal	Cu
D	Inner El	ectrode	Ni
E	Dielectric	Material	CaZrO ₃



Note: Image is exaggerated in order to clearly identify all components of construction.

Capacitor Marking (Optional):

Laser marking option is not available on:

- C0G, Ultra Stable X8R and Y5V dielectric devices
- EIA 0402 case size devices
- EIA 0603 case size devices with Flexible Termination option.
- KPS Commercial and Automotive grade stacked devices.

These capacitors are supplied unmarked only.



Tape & Reel Packaging Information

KEMET offers multilayer ceramic chip capacitors packaged in 8, 12 and 16 mm tape on 7" and 13" reels in accordance with EIA Standard 481. This packaging system is compatible with all tape-fed automatic pick and place systems. See Table 2 for details on reeling quantities for commercial chips.

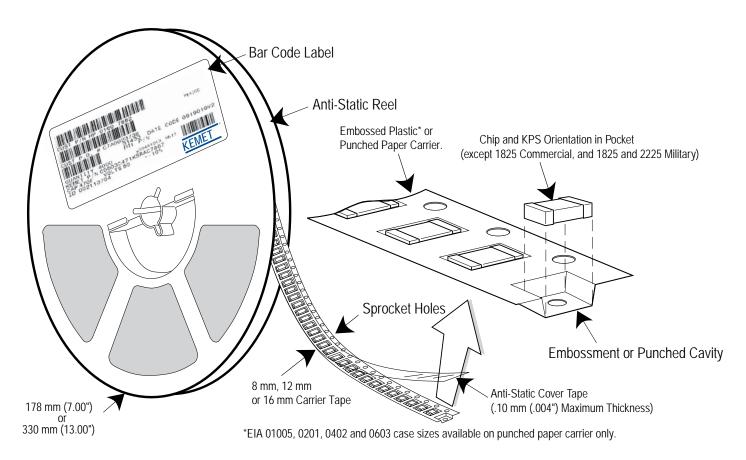


Table 5 – Carrier Tape Configuration – Embossed Plastic & Punched Paper (mm)

EIA Case Size	Tape Size (W)*	Pitch (P ₁)*
01005 – 0402	8	2
0603 – 1210	8	4
1805 – 1808	12	4
≥ 1812	12	8
KPS 1210	12	8
KPS 1812 & 2220	16	12
Array 0508 & 0612	8	4

^{*}Refer to Figures 1 & 2 for W and P, carrier tape reference locations.

^{*}Refer to Tables 6 & 7 for tolerance specifications.



Figure 1 – Embossed (Plastic) Carrier Tape Dimensions

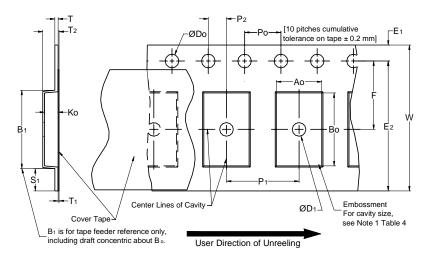


Table 6 - Embossed (Plastic) Carrier Tape Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)									
Tape Size	D ₀	D ₁ Minimum Note 1	E ₁	P ₀	P ₂	R Reference Note 2	S ₁ Minimum Note 3	T Maximum	T ₁ Maximum
8 mm		1.0 (0.039)				25.0 (0.984)			
12 mm	1.5 +0.10/-0.0 (0.059 +0.004/-0.0)	1.5	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	30	0.600 (0.024)	0.600 (0.024)	0.100 (0.004)
16 mm	(0.059)					(1.181)			
			Variable Dime	ensions — Mil	limeters (Inch	es)			
Tape Size	Tape Size Pitch B ₁ Maximum E ₂ F P ₁ T ₂ W Maximum A ₀ ,B ₀ & K ₀					& K ₀			
8 mm	Single (4 mm)	4.35 (0.171)	6.25 (0.246)	3.5 ±0.05 (0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	2.5 (0.098)	8.3 (0.327)		
12 mm	Single (4 mm) & Double (8 mm)	8.2 (0.323)	10.25 (0.404)	5.5 ±0.05 (0.217 ±0.002)	8.0 ±0.10 (0.315 ±0.004)	4.6 (0.181)	12.3 (0.484)	No	e 5
16 mm	Triple (12 mm)	12.1 (0.476)	14.25 (0.561)	7.5 ±0.05 (0.138 ±0.002)	12.0 ±0.10 (0.157 ±0.004)	4.6 (0.181)	16.3 (0.642)		

- 1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location and hole location shall be applied independent of each other.
- 2. The tape with or without components shall pass around R without damage (see Figure 6).
- 3. If S₁ < 1.0 mm, there may not be enough area for cover tape to be properly applied (see EIA Standard 481 paragraph 4.3 section b).
- 4. B, dimension is a reference dimension for tape feeder clearance only.
- 5. The cavity defined by A_a, B_a and K_a shall surround the component with sufficient clearance that:
 - (a) the component does not protrude above the top surface of the carrier tape.
 - (b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
 - (c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes and 10° maximum for 16 mm tapes (see Figure 3).
 - (d) lateral movement of the component is restricted to 0.5 mm maximum for 8 and 12 mm wide tape and to 1.0 mm maximum for 16 mm tape (see Figure 4).
 - (e) for KPS Series product, A_a and B_a are measured on a plane 0.3 mm above the bottom of the pocket.
 - (f) see Addendum in EIA Standard 481 for standards relating to more precise taping requirements.



Figure 2 – Punched (Paper) Carrier Tape Dimensions

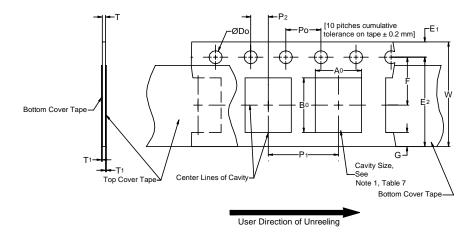


Table 7 - Punched (Paper) Carrier Tape Dimensions

Metric will govern

	Constant Dimensions — Millimeters (Inches)								
Tape Size	D _o	E ₁	P ₀	P ₂	T ₁ Maximum	G Minimum	R Reference Note 2		
8 mm	1.5 +0.10 -0.0 (0.059 +0.004 -0.0)	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	0.10 (0.004) Maximum	0.75 (0.030)	25 (0.984)		
	Variable Dimensions — Millimeters (Inches)								
Tape Size	Pitch	E2 Minimum	F	P ₁	T Maximum	W Maximum	A_0B_0		
8 mm	Half (2 mm)	6.25	3.5 ±0.05	2.0 ±0.05 (0.079 ±0.002)	1.1	8.3 (0.327)	Note 1		
8 mm	Single (4 mm)	(0.246)	(0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	(0.098)	8.3 (0.327)	Note I		

- 1. The cavity defined by A_{σ} , B_{σ} and T shall surround the component with sufficient clearance that:
 - a) the component does not protrude beyond either surface of the carrier tape.
 - b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
 - c) rotation of the component is limited to 20° maximum (see Figure 3).
 - d) lateral movement of the component is restricted to 0.5 mm maximum (see Figure 4).
- e) see Addendum in EIA Standard 481 for standards relating to more precise taping requirements.
- 2. The tape with or without components shall pass around R without damage (see Figure 6).



Packaging Information Performance Notes

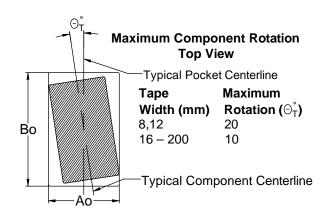
- 1. Cover Tape Break Force: 1.0 Kg minimum.
- 2. Cover Tape Peel Strength: The total peel strength of the cover tape from the carrier tape shall be:

Tape Width	Peel Strength
8 mm	0.1 to 1.0 Newton (10 to 100 gf)
12 and 16 mm	0.1 to 1.3 Newton (10 to 130 gf)

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165 $^{\circ}$ to 180 $^{\circ}$ from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300 \pm 10 mm/minute.

3. Labeling: Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. *Refer to EIA Standards 556 and 624.*

Figure 3 – Maximum Component Rotation



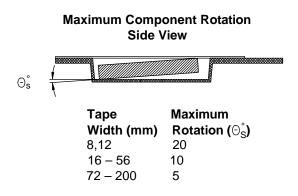


Figure 4 – Maximum Lateral Movement

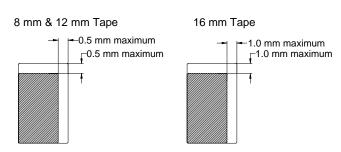


Figure 5 - Bending Radius

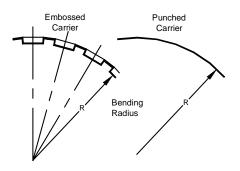
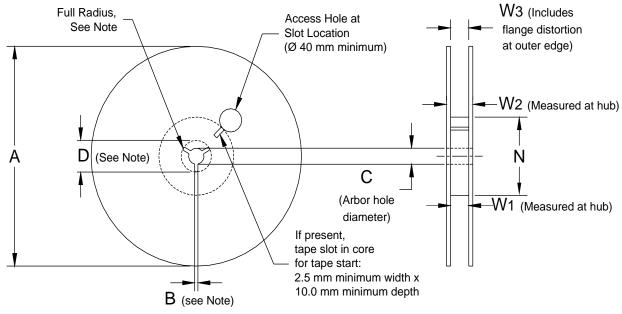




Figure 6 - Reel Dimensions



Note: Drive spokes optional; if used, dimensions B and D shall apply.

Table 8 - Reel Dimensions

Metric will govern

	Constant Dimensions — Millimeters (Inches)							
Tape Size	A	B Minimum	С	D Minimum				
8 mm	178 ±0.20							
12 mm	(7.008 ±0.008) or	1.5 (0.059)	13.0 +0.5/-0.2 (0.521 +0.02/-0.008)	20.2 (0.795)				
16 mm	330 ±0.20 (13.000 ±0.008)	(0.000)						
	Variable	Dimensions — Millimeter	s (Inches)					
Tape Size	N Minimum	W ₁	W ₂ Maximum	W ₃				
8 mm		8.4 +1.5/-0.0 (0.331 +0.059/-0.0)	14.4 (0.567)					
12 mm	50 (1.969)	12.4 +2.0/-0.0 (0.488 +0.078/-0.0)	18.4 (0.724)	Shall accommodate tape width without interference				
16 mm		16.4 +2.0/-0.0 (0.646 +0.078/-0.0)	22.4 (0.882)					



Figure 7 - Tape Leader & Trailer Dimensions

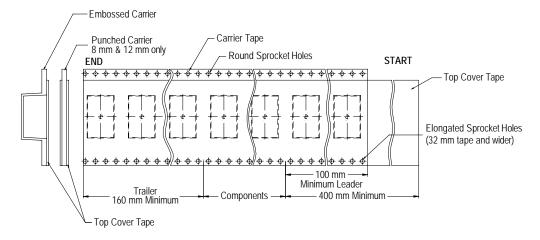
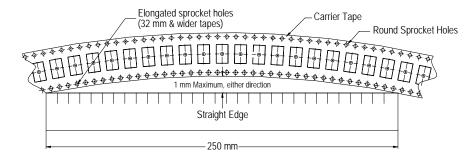
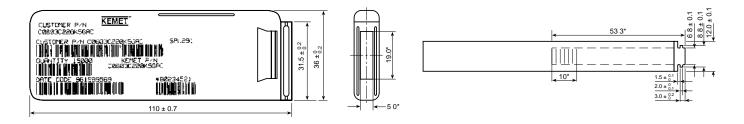


Figure 8 – Maximum Camber



Bulk Cassette Packaging (Ceramic Chips Only)

Meets Dimensional Requirements IEC–286 and EIAJ 7201 *Unit mm *Reference*



Capacitor Dimensions for Bulk Cassette

Cassette Packaging - Millimeters

EIA Size Code	Metric Size Code	L Length	W Width	B Bandwidth	S Separation Minimum	T Thickness	Number of Pieces/Cassette
0402	1005	1.0 ±0.05	0.5 ±0.05	0.2 to 0.4	0.3	0.5 ±0.05	50,000
0603	1608	1.6 ±0.07	0.8 ±0.07	0.2 to 0.5	0.7	0.8 ±0.07	15,000



KEMET Corporation World Headquarters

2835 KEMET Way Simpsonville, SC 29681

Mailing Address: P.O. Box 5928 Greenville, SC 29606

www.kemet.com Tel: 864-963-6300 Fax: 864-963-6521

Corporate Offices

Fort Lauderdale, FL Tel: 954-766-2800

North America

Southeast

Lake Mary, FL Tel: 407-855-8886

Northeast

Wilmington, MA Tel: 978-658-1663

Central

Novi, MI

Tel: 248-994-1030

West

Milpitas, CA Tel: 408-433-9950

Mexico

Guadalajara, Jalisco Tel: 52-33-3123-2141

Europe

Southern Europe

Paris. France Tel: 33-1-4646-1006

Sasso Marconi, Italy Tel: 39-051-939111

Central Europe

Landsberg, Germany Tel: 49-8191-3350800

Kamen, Germany Tel: 49-2307-438110

Northern Europe

Bishop's Stortford, United Kingdom Tel: 44-1279-460122

Espoo, Finland

Tel: 358-9-5406-5000

Asia

Northeast Asia

Hong Kong

Tel: 852-2305-1168

Shenzhen, China Tel: 86-755-2518-1306

Beijing, China

Tel: 86-10-5829-1711

Shanghai, China Tel: 86-21-6447-0707

Taipei, Taiwan Tel: 886-2-27528585

Southeast Asia

Singapore

Tel: 65-6586-1900

Penang, Malaysia Tel: 60-4-6430200

Bangalore, India Tel: 91-806-53-76817

Note: KEMET reserves the right to modify minor details of internal and external construction at any time in the interest of product improvement. KEMET does not assume any responsibility for infringement that might result from the use of KEMET Capacitors in potential circuit designs. KEMET is a registered trademark of KEMET Electronics Corporation.



Other KEMET Resources

Tools				
Resource	Location			
Configure A Part: CapEdge	http://capacitoredge.kemet.com			
SPICE & FIT Software	http://www.kemet.com/spice			
Search Our FAQs: KnowledgeEdge	http://www.kemet.com/keask			
Electrolytic LifeCalculator	http://www.kemet.com:8080/elc			

Product Information			
Resource	Location		
Products	http://www.kemet.com/products		
Technical Resources (Including Soldering Techniques)	http://www.kemet.com/technicalpapers		
RoHS Statement	http://www.kemet.com/rohs		
Quality Documents	http://www.kemet.com/qualitydocuments		

Product Request			
Resource Location			
Sample Request	http://www.kemet.com/sample		
Engineering Kit Request	http://www.kemet.com/kits		

Contact				
Resource	Location			
Website	www.kemet.com			
Contact Us	http://www.kemet.com/contact			
Investor Relations	http://www.kemet.com/ir			
Call Us	1-877-MyKEMET			
Twitter	http://twitter.com/kemetcapacitors			

Disclaimer

All product specifications, statements, information and data (collectively, the "Information") are subject to change without notice.

All Information given herein is believed to be accurate and reliable, but is presented without guarantee, warranty, or responsibility of any kind, expressed or implied.

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Although we design and manufacture our products to the most stringent quality and safety standards, given the current state of the art, isolated component failures may still occur. Accordingly, customer applications which require a high degree of reliability or safety should employ suitable designs or other safeguards (such as installation of protective circuitry or redundancies) in order to ensure that the failure of an electrical component does not result in a risk of personal injury or property damage.

Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicated or that other measures may not be required.

